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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Active
Number of LABs/CLBs	37950
Number of Logic Elements/Cells	485760
Total RAM Bits	37969920
Number of I/O	600
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1924-BBGA, FCBGA
Supplier Device Package	1927-FCBGA (45x45)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc7vx485t-1ff1927c">https://www.e-xfl.com/product-detail/xilinx/xc7vx485t-1ff1927c</a>

## Power-On/Off Power Supply Sequencing

The recommended power-on sequence is  $V_{CCINT}$ ,  $V_{CCBRAM}$ ,  $V_{CCAUX}$ ,  $V_{CCAUX\_IO}$ , and  $V_{CCO}$  to achieve minimum current draw and ensure that the I/Os are 3-stated at power-on. The recommended power-off sequence is the reverse of the power-on sequence. If  $V_{CCINT}$  and  $V_{CCBRAM}$  have the same recommended voltage levels then both can be powered by the same supply and ramped simultaneously. If  $V_{CCAUX}$ ,  $V_{CCAUX\_IO}$ , and  $V_{CCO}$  have the same recommended voltage levels then they can be powered by the same supply and ramped simultaneously.

For  $V_{CCO}$  voltages of 3.3V in HR I/O banks and configuration bank 0:

- The voltage difference between  $V_{CCO}$  and  $V_{CCAUX}$  must not exceed 2.625V for longer than  $T_{VCCO2VCCAUX}$  for each power-on/off cycle to maintain device reliability levels.
- The  $T_{VCCO2VCCAUX}$  time can be allocated in any percentage between the power-on and power-off ramps.

The recommended power-on sequence to achieve minimum current draw for the GTX/GTH transceivers is  $V_{CCINT}$ ,  $V_{MGTAVCC}$ ,  $V_{MGTAVTT}$  OR  $V_{MGTAVCC}$ ,  $V_{CCINT}$ ,  $V_{MGTAVTT}$ . There is no recommended sequencing for  $V_{MGTAVCAUX}$ . Both  $V_{MGTAVCC}$  and  $V_{CCINT}$  can be ramped simultaneously. The recommended power-off sequence is the reverse of the power-on sequence to achieve minimum current draw.

If these recommended sequences are not met, current drawn from  $V_{MGTAVTT}$  can be higher than specifications during power-up and power-down.

- When  $V_{MGTAVTT}$  is powered before  $V_{MGTAVCC}$  and  $V_{MGTAVTT} - V_{MGTAVCC} > 150$  mV and  $V_{MGTAVCC} < 0.7$ V, the  $V_{MGTAVTT}$  current draw can increase by 460 mA per transceiver during  $V_{MGTAVCC}$  ramp up. The duration of the current draw can be up to  $0.3 \times T_{MGTAVCC}$  (ramp time from GND to 90% of  $V_{MGTAVCC}$ ). The reverse is true for power-down.
- When  $V_{MGTAVTT}$  is powered before  $V_{CCINT}$  and  $V_{MGTAVTT} - V_{CCINT} > 150$  mV and  $V_{CCINT} < 0.7$ V, the  $V_{MGTAVTT}$  current draw can increase by 50 mA per transceiver during  $V_{CCINT}$  ramp up. The duration of the current draw can be up to  $0.3 \times T_{VCCINT}$  (ramp time from GND to 90% of  $V_{CCINT}$ ). The reverse is true for power-down.

**Table 7** shows the minimum current, in addition to  $I_{CCQ}$ , that is required by Virtex-7 T and XT devices for proper power-on and configuration. If the current minimums shown in **Table 6** and **Table 7** are met, the device powers on after all five supplies have passed through their power-on reset threshold voltages. The FPGA must not be configured until after  $V_{CCINT}$  is applied.

Once initialized and configured, use the XPower tools to estimate current drain on these supplies.

**Table 7: Power-On Current for Virtex-7 T and XT Devices**

Device	$I_{CCINTMIN}$	$I_{CCAUXMIN}$	$I_{CCOMIN}$	$I_{CCAUX\_IO}$	$I_{CCBRAM}$	Units
	$I_{CCINTQ}^{(1)}$	$I_{CCAUXQ}^{(1)}$	$I_{CCOQ}^{(1)}$	$I_{CCOAUQ}^{(1)}$	$I_{CCBRAMQ}^{(1)}$	
XC7V585T	$I_{CCINTQ} + 2700$	$I_{CCAUXQ} + 40$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 108$	mA
XC7V2000T	$I_{CCINTQ} + 4000$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 60 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 176$	mA
XC7VX330T	$I_{CCINTQ} + 1000$	$I_{CCAUXQ} + 65$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 95$	mA
XC7VX415T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 75$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 115$	mA
XC7VX485T	$I_{CCINTQ} + 1200$	$I_{CCAUXQ} + 80$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 40 \text{ mA per bank}$	$I_{CCBRAMQ} + 140$	mA
XC7VX550T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX690T	$I_{CCINTQ} + 3300$	$I_{CCAUXQ} + 143$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 57 \text{ mA per bank}$	$I_{CCBRAMQ} + 200$	mA
XC7VX980T	$I_{CCINTQ} + 6500$	$I_{CCAUXQ} + 202$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 60 \text{ mA per bank}$	$I_{CCBRAMQ} + 204$	mA
XC7VX1140T	$I_{CCINTQ} + 8000$	$I_{CCAUXQ} + 235$	$I_{CCOQ} + 40 \text{ mA per bank}$	$I_{CCOAUQ} + 63 \text{ mA per bank}$	$I_{CCBRAMQ} + 256$	mA

**Notes:**

1. Typical values are specified at nominal voltage, 25°C.
2. Use the Xilinx Power Estimator (XPE) spreadsheet tool (download at <http://www.xilinx.com/power>) to calculate maximum power-on currents.

**Table 8: Power Supply Ramp Time**

Symbol	Description	Conditions	Min	Max	Units
$T_{VCCINT}$	Ramp time from GND to 90% of $V_{CCINT}$		0.2	50	ms
$T_{VCCO}$	Ramp time from GND to 90% of $V_{CCO}$		0.2	50	ms
$T_{VCCAUX}$	Ramp time from GND to 90% of $V_{CCAUX}$		0.2	50	ms
$T_{VCCAUX\_IO}$	Ramp time from GND to 90% of $V_{CCAUX\_IO}$		0.2	50	ms
$T_{CCBRAM}$	Ramp time from GND to 90% of $V_{CCBRAM}$		0.2	50	ms
$T_{VCCO2VCCAUX}$	Allowed time per power cycle for $V_{CCO} - V_{CCAUX} > 2.625\text{V}$	$T_J = 100^\circ\text{C}^{(1)}$	–	500	ms
		$T_J = 85^\circ\text{C}^{(1)}$	–	800	
$T_{MGTAVCC}$	Ramp time from GND to 90% of $V_{MGTAVCC}$		0.2	50	ms
$T_{MGTAVTT}$	Ramp time from GND to 90% of $V_{MGTAVTT}$		0.2	50	ms
$T_{MGTVCCAUX}$	Ramp time from GND to 90% of $V_{MGTVCCAUX}$		0.2	50	ms

**Notes:**

1. Based on 240,000 power cycles with nominal  $V_{CCO}$  of 3.3V or 36,500 power cycles with a worst case  $V_{CCO}$  of 3.465V.

## LVDS DC Specifications (LVDS\_25)

The LVDS standard is available in the HR I/O banks.

**Table 12: LVDS\_25 DC Specifications<sup>(1)</sup>**

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units
$V_{CCO}$	Supply voltage		2.375	2.500	2.625	V
$V_{OH}$	Output High voltage for Q and $\bar{Q}$	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	–	–	1.675	V
$V_{OL}$	Output Low voltage for Q and $\bar{Q}$	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	0.700	–	–	V
$V_{ODIFF}$	Differential output voltage ( $Q - \bar{Q}$ ), Q = High ( $Q - Q$ ), $\bar{Q}$ = High	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	247	350	600	mV
$V_{OCM}$	Output common-mode voltage	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	1.000	1.250	1.425	V
$V_{IDIFF}$	Differential input voltage ( $Q - \bar{Q}$ ), Q = High ( $\bar{Q} - Q$ ), $\bar{Q}$ = High		100	350	600	mV
$V_{ICM}$	Input common-mode voltage		0.300	1.200	1.425	V

**Notes:**

1. Differential inputs for LVDS\_25 can be placed in banks with  $V_{CCO}$  levels that are different from the required level for outputs. Consult the 7 Series FPGAs SelectIO Resources User Guide ([UG471](#)) for more information.

## LVDS DC Specifications (LVDS)

The LVDS standard is available in the HP I/O banks.

**Table 13: LVDS DC Specifications**

Symbol	DC Parameter	Conditions	Min	Typ	Max	Units
$V_{CCO}$	Supply voltage		1.710	1.800	1.890	V
$V_{OH}$	Output High voltage for Q and $\bar{Q}$	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	–	–	1.675	V
$V_{OL}$	Output Low voltage for Q and $\bar{Q}$	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	0.825	–	–	V
$V_{ODIFF}$	Differential output voltage ( $Q - \bar{Q}$ ), Q = High ( $Q - Q$ ), $\bar{Q}$ = High	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	247	350	600	mV
$V_{OCM}$	Output common-mode voltage	$R_T = 100 \Omega$ across Q and $\bar{Q}$ signals	1.000	1.250	1.425	V
$V_{IDIFF}$	Differential input voltage ( $Q - \bar{Q}$ ), Q = High ( $\bar{Q} - Q$ ), $\bar{Q}$ = High	Common-mode input voltage = 1.25V	100	350	600	mV
$V_{ICM}$	Input common-mode voltage	Differential input voltage = ±350 mV	0.300	1.200	1.425	V

**Notes:**

1. Differential inputs for LVDS can be placed in banks with  $V_{CCO}$  levels that are different from the required level for outputs. Consult the 7 Series FPGAs SelectIO Resources User Guide ([UG471](#)) for more information.

Table 19: 3.3V IOB High Range (HR) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
HSTL_II_F	0.61	0.64	0.73	1.05	1.18	1.28	1.81	2.04	2.27	ns	
HSTL_I_18_F	0.64	0.67	0.76	1.05	1.18	1.28	1.81	2.04	2.27	ns	
HSTL_II_18_F	0.64	0.67	0.76	1.03	1.14	1.23	1.79	2.00	2.22	ns	
DIFF_HSTL_I_F	0.63	0.67	0.77	1.09	1.18	1.22	1.85	2.04	2.21	ns	
DIFF_HSTL_II_F	0.63	0.67	0.77	1.02	1.11	1.14	1.78	1.97	2.13	ns	
DIFF_HSTL_I_18_F	0.65	0.69	0.78	1.08	1.17	1.21	1.84	2.03	2.20	ns	
DIFF_HSTL_II_18_F	0.65	0.69	0.78	1.01	1.10	1.13	1.77	1.96	2.12	ns	
LVCMOS33_S4	1.31	1.40	1.60	3.77	3.90	4.00	4.53	4.76	4.99	ns	
LVCMOS33_S8	1.31	1.40	1.60	3.49	3.62	3.72	4.25	4.48	4.71	ns	
LVCMOS33_S12	1.31	1.40	1.60	3.05	3.18	3.28	3.81	4.04	4.27	ns	
LVCMOS33_S16	1.31	1.40	1.60	3.06	3.43	3.88	3.82	4.29	4.87	ns	
LVCMOS33_F4	1.31	1.40	1.60	3.22	3.36	3.45	3.98	4.22	4.44	ns	
LVCMOS33_F8	1.31	1.40	1.60	2.71	2.84	2.93	3.47	3.70	3.92	ns	
LVCMOS33_F12	1.31	1.40	1.60	2.57	2.85	3.15	3.33	3.71	4.14	ns	
LVCMOS33_F16	1.31	1.40	1.60	2.44	2.69	2.96	3.20	3.55	3.95	ns	
LVCMOS25_S4	1.08	1.16	1.32	3.08	3.22	3.31	3.84	4.08	4.30	ns	
LVCMOS25_S8	1.08	1.16	1.32	2.85	2.98	3.07	3.61	3.84	4.06	ns	
LVCMOS25_S12	1.08	1.16	1.32	2.44	2.57	2.67	3.20	3.43	3.66	ns	
LVCMOS25_S16	1.08	1.16	1.32	2.79	2.92	3.01	3.55	3.78	4.00	ns	
LVCMOS25_F4	1.08	1.16	1.32	2.71	2.84	2.93	3.47	3.70	3.92	ns	
LVCMOS25_F8	1.08	1.16	1.32	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS25_F12	1.08	1.16	1.32	2.15	2.29	2.52	2.91	3.15	3.51	ns	
LVCMOS25_F16	1.08	1.16	1.32	1.92	2.17	2.45	2.68	3.03	3.44	ns	
LVCMOS18_S4	0.64	0.66	0.74	1.55	1.68	1.78	2.31	2.54	2.77	ns	
LVCMOS18_S8	0.64	0.66	0.74	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS18_S12	0.64	0.66	0.74	2.14	2.28	2.37	2.90	3.14	3.36	ns	
LVCMOS18_S16	0.64	0.66	0.74	1.49	1.62	1.72	2.25	2.48	2.71	ns	
LVCMOS18_S24 <sup>(1)</sup>	0.64	0.66	0.74	1.74	1.92	2.08	2.50	2.78	3.07	ns	
LVCMOS18_F4	0.64	0.66	0.74	1.38	1.51	1.61	2.14	2.37	2.60	ns	
LVCMOS18_F8	0.64	0.66	0.74	1.64	1.78	1.87	2.40	2.64	2.86	ns	
LVCMOS18_F12	0.64	0.66	0.74	1.64	1.78	1.87	2.40	2.64	2.86	ns	
LVCMOS18_F16	0.64	0.66	0.74	1.52	1.68	1.81	2.28	2.54	2.80	ns	
LVCMOS18_F24 <sup>(1)</sup>	0.64	0.66	0.74	1.34	1.46	1.55	2.10	2.32	2.54	ns	
LVCMOS15_S4	0.66	0.69	0.81	1.86	2.00	2.09	2.62	2.86	3.08	ns	
LVCMOS15_S8	0.66	0.69	0.81	2.05	2.18	2.28	2.81	3.04	3.27	ns	
LVCMOS15_S12	0.66	0.69	0.81	1.83	2.03	2.23	2.59	2.89	3.22	ns	
LVCMOS15_S16	0.66	0.69	0.81	1.76	1.95	2.13	2.52	2.81	3.12	ns	

Table 20: 1.8V IOB High Performance (HP) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
DIFF_HSTL_I_18_F	0.75	0.79	0.92	1.04	1.16	1.24	1.68	1.91	2.06	ns	
DIFF_HSTL_II_18_F	0.75	0.79	0.92	0.98	1.09	1.16	1.62	1.85	1.98	ns	
DIFF_HSTL_I_DCI_18_F	0.75	0.79	0.92	1.04	1.16	1.24	1.67	1.91	2.06	ns	
DIFF_HSTL_II_DCI_18_F	0.75	0.79	0.92	0.98	1.09	1.16	1.61	1.85	1.98	ns	
DIFF_HSTL_II_T_DCI_18_F	0.75	0.79	0.92	1.04	1.16	1.24	1.67	1.91	2.06	ns	
LVCMOS18_S2	0.47	0.50	0.60	3.95	4.28	4.85	4.59	5.04	5.67	ns	
LVCMOS18_S4	0.47	0.50	0.60	2.67	2.98	3.43	3.31	3.73	4.26	ns	
LVCMOS18_S6	0.47	0.50	0.60	2.14	2.38	2.72	2.77	3.14	3.54	ns	
LVCMOS18_S8	0.47	0.50	0.60	1.98	2.21	2.52	2.61	2.97	3.35	ns	
LVCMOS18_S12	0.47	0.50	0.60	1.70	1.91	2.17	2.34	2.67	2.99	ns	
LVCMOS18_S16	0.47	0.50	0.60	1.57	1.75	1.97	2.20	2.51	2.79	ns	
LVCMOS18_F2	0.47	0.50	0.60	3.50	3.87	4.48	4.14	4.63	5.30	ns	
LVCMOS18_F4	0.47	0.50	0.60	2.23	2.50	2.87	2.87	3.25	3.69	ns	
LVCMOS18_F6	0.47	0.50	0.60	1.80	2.00	2.26	2.43	2.76	3.08	ns	
LVCMOS18_F8	0.47	0.50	0.60	1.46	1.72	2.04	2.10	2.47	2.86	ns	
LVCMOS18_F12	0.47	0.50	0.60	1.26	1.40	1.53	1.89	2.16	2.35	ns	
LVCMOS18_F16	0.47	0.50	0.60	1.19	1.33	1.44	1.83	2.08	2.26	ns	
LVCMOS15_S2	0.59	0.62	0.73	3.55	3.89	4.45	4.19	4.65	5.27	ns	
LVCMOS15_S4	0.59	0.62	0.73	2.45	2.70	3.06	3.08	3.45	3.89	ns	
LVCMOS15_S6	0.59	0.62	0.73	2.24	2.51	2.88	2.88	3.26	3.71	ns	
LVCMOS15_S8	0.59	0.62	0.73	1.91	2.16	2.49	2.55	2.91	3.31	ns	
LVCMOS15_S12	0.59	0.62	0.73	1.77	1.98	2.23	2.41	2.73	3.05	ns	
LVCMOS15_S16	0.59	0.62	0.73	1.62	1.81	2.02	2.26	2.56	2.84	ns	
LVCMOS15_F2	0.59	0.62	0.73	3.38	3.69	4.18	4.02	4.44	5.00	ns	
LVCMOS15_F4	0.59	0.62	0.73	2.04	2.21	2.44	2.68	2.97	3.26	ns	
LVCMOS15_F6	0.59	0.62	0.73	1.47	1.74	2.09	2.10	2.50	2.91	ns	
LVCMOS15_F8	0.59	0.62	0.73	1.31	1.46	1.61	1.95	2.22	2.43	ns	
LVCMOS15_F12	0.59	0.62	0.73	1.21	1.34	1.45	1.84	2.10	2.27	ns	
LVCMOS15_F16	0.59	0.62	0.73	1.18	1.31	1.41	1.82	2.07	2.23	ns	
LVCMOS12_S2	0.64	0.67	0.78	3.38	3.80	4.48	4.02	4.55	5.30	ns	
LVCMOS12_S4	0.64	0.67	0.78	2.62	2.94	3.43	3.26	3.70	4.25	ns	
LVCMOS12_S6	0.64	0.67	0.78	2.05	2.33	2.72	2.69	3.08	3.54	ns	
LVCMOS12_S8	0.64	0.67	0.78	1.94	2.18	2.51	2.58	2.94	3.33	ns	
LVCMOS12_F2	0.64	0.67	0.78	2.84	3.15	3.62	3.48	3.90	4.44	ns	
LVCMOS12_F4	0.64	0.67	0.78	1.97	2.18	2.44	2.61	2.93	3.26	ns	
LVCMOS12_F6	0.64	0.67	0.78	1.33	1.51	1.70	1.96	2.26	2.52	ns	
LVCMOS12_F8	0.64	0.67	0.78	1.27	1.42	1.55	1.91	2.18	2.37	ns	
LVDCI_18	0.47	0.50	0.60	1.99	2.15	2.35	2.62	2.91	3.17	ns	

Table 20: 1.8V IOB High Performance (HP) Switching Characteristics (Cont'd)

I/O Standard	T <sub>IOPI</sub>			T <sub>IOOP</sub>			T <sub>IOTP</sub>			Units	
	Speed Grade			Speed Grade			Speed Grade				
	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1	-3	-2/-2L/-2G	-1		
LVDCI_15	0.59	0.62	0.73	1.98	2.23	2.58	2.62	2.99	3.40	ns	
LVDCI_DV2_18	0.47	0.50	0.60	1.99	2.15	2.34	2.62	2.90	3.17	ns	
LVDCI_DV2_15	0.59	0.62	0.73	1.98	2.23	2.58	2.62	2.99	3.40	ns	
HSLVDCI_18	0.68	0.72	0.82	1.99	2.15	2.35	2.62	2.91	3.17	ns	
HSLVDCI_15	0.68	0.72	0.82	1.98	2.23	2.58	2.62	2.99	3.40	ns	
SSTL18_I_S	0.68	0.72	0.82	1.02	1.15	1.24	1.66	1.90	2.07	ns	
SSTL18_II_S	0.68	0.72	0.82	1.17	1.29	1.37	1.81	2.05	2.19	ns	
SSTL18_I_DCI_S	0.68	0.72	0.82	0.92	1.06	1.17	1.56	1.82	1.99	ns	
SSTL18_II_DCI_S	0.68	0.72	0.82	0.88	0.98	1.08	1.51	1.74	1.90	ns	
SSTL18_II_T_DCI_S	0.68	0.72	0.82	0.92	1.06	1.17	1.56	1.82	1.99	ns	
SSTL15_S	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
SSTL15_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
SSTL15_T_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
SSTL135_S	0.69	0.72	0.82	0.97	1.10	1.19	1.60	1.85	2.01	ns	
SSTL135_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
SSTL135_T_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
SSTL12_S	0.69	0.72	0.82	0.96	1.09	1.18	1.60	1.84	2.00	ns	
SSTL12_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
SSTL12_T_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
DIFF_SSTL18_I_S	0.75	0.79	0.92	1.02	1.15	1.24	1.66	1.90	2.07	ns	
DIFF_SSTL18_II_S	0.75	0.79	0.92	1.17	1.29	1.37	1.81	2.05	2.19	ns	
DIFF_SSTL18_I_DCI_S	0.75	0.79	0.92	0.92	1.06	1.17	1.56	1.82	1.99	ns	
DIFF_SSTL18_II_DCI_S	0.75	0.79	0.92	0.88	0.98	1.08	1.51	1.74	1.90	ns	
DIFF_SSTL18_II_T_DCI_S	0.75	0.79	0.92	0.92	1.06	1.17	1.56	1.82	1.99	ns	
DIFF_SSTL15_S	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
DIFF_SSTL15_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
DIFF_SSTL15_T_DCI_S	0.68	0.72	0.82	0.94	1.06	1.15	1.57	1.82	1.97	ns	
DIFF_SSTL135_S	0.69	0.72	0.82	0.97	1.10	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL135_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL135_T_DCI_S	0.69	0.72	0.82	0.97	1.09	1.19	1.60	1.85	2.01	ns	
DIFF_SSTL12_S	0.69	0.72	0.82	0.96	1.09	1.18	1.60	1.84	2.00	ns	
DIFF_SSTL12_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
DIFF_SSTL12_T_DCI_S	0.69	0.72	0.82	1.03	1.17	1.27	1.66	1.92	2.09	ns	
SSTL18_I_F	0.68	0.72	0.82	0.94	1.06	1.15	1.58	1.82	1.97	ns	
SSTL18_II_F	0.68	0.72	0.82	0.97	1.09	1.16	1.61	1.84	1.99	ns	
SSTL18_I_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	
SSTL18_II_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	
SSTL18_II_T_DCI_F	0.68	0.72	0.82	0.89	1.02	1.10	1.53	1.77	1.92	ns	

## CLB Distributed RAM Switching Characteristics (SLICEM Only)

Table 29: CLB Distributed RAM Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Sequential Delays</b>					
T <sub>SHCKO</sub> <sup>(1)</sup>	Clock to A – B outputs	0.68	0.70	0.85	ns, Max
T <sub>SHCKO_1</sub>	Clock to AMUX – BMUX outputs	0.91	0.95	1.15	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>					
T <sub>DS_LRAM</sub> /T <sub>DH_LRAM</sub>	A – D inputs to CLK	0.45/0.23	0.45/0.24	0.54/0.27	ns, Min
T <sub>AS_LRAM</sub> /T <sub>AH_LRAM</sub>	Address An inputs to clock	0.13/0.50	0.14/0.50	0.17/0.58	ns, Min
	Address An inputs through MUXs and/or carry logic to clock	0.40/0.16	0.42/0.17	0.52/0.23	ns, Min
T <sub>WS_LRAM</sub> /T <sub>WH_LRAM</sub>	WE input to clock	0.29/0.09	0.30/0.09	0.36/0.09	ns, Min
T <sub>CECK_LRAM</sub> /T <sub>CKCE_LRAM</sub>	CE input to CLK	0.29/0.09	0.30/0.09	0.37/0.09	ns, Min
<b>Clock CLK</b>					
T <sub>MPW</sub>	Minimum pulse width	0.68	0.77	0.91	ns, Min
T <sub>MCP</sub>	Minimum clock period	1.35	1.54	1.82	ns, Min

**Notes:**

1. T<sub>SHCKO</sub> also represents the CLK to XMUX output. Refer to the timing report for the CLK to XMUX path.

## CLB Shift Register Switching Characteristics (SLICEM Only)

Table 30: CLB Shift Register Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Sequential Delays</b>					
T <sub>REG</sub>	Clock to A – D outputs	0.96	0.98	1.20	ns, Max
T <sub>REG_MUX</sub>	Clock to AMUX – DMUX output	1.19	1.23	1.50	ns, Max
T <sub>REG_M31</sub>	Clock to DMUX output via M31 output	0.89	0.91	1.10	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>					
T <sub>WS_SHFREG</sub> /T <sub>WH_SHFREG</sub>	WE input	0.26/0.09	0.27/0.09	0.33/0.09	ns, Min
T <sub>CECK_SHFREG</sub> /T <sub>CKCE_SHFREG</sub>	CE input to CLK	0.27/0.09	0.28/0.09	0.33/0.09	ns, Min
T <sub>DS_SHFREG</sub> /T <sub>DH_SHFREG</sub>	A – D inputs to CLK	0.28/0.26	0.28/0.26	0.33/0.30	ns, Min
<b>Clock CLK</b>					
T <sub>MPW_SHFREG</sub>	Minimum pulse width	0.55	0.65	0.78	ns, Min

## Block RAM and FIFO Switching Characteristics

Table 31: Block RAM and FIFO Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Block RAM and FIFO Clock-to-Out Delays</b>					
T <sub>RCKO_DO</sub> and T <sub>RCKO_DO_REG</sub> <sup>(1)</sup>	Clock CLK to DOUT output (without output register) <sup>(2)(3)</sup>	1.57	1.80	2.08	ns, Max
	Clock CLK to DOUT output (with output register) <sup>(4)(5)</sup>	0.54	0.63	0.75	ns, Max
T <sub>RCKO_DO_ECC</sub> and T <sub>RCKO_DO_ECC_REG</sub>	Clock CLK to DOUT output with ECC (without output register) <sup>(2)(3)</sup>	2.35	2.58	3.26	ns, Max
	Clock CLK to DOUT output with ECC (with output register) <sup>(4)(5)</sup>	0.62	0.69	0.80	ns, Max
T <sub>RCKO_DO_CASCOUP</sub> and T <sub>RCKO_DO_CASCOUP_REG</sub>	Clock CLK to DOUT output with Cascade (without output register) <sup>(2)</sup>	2.21	2.45	2.80	ns, Max
	Clock CLK to DOUT output with Cascade (with output register) <sup>(4)</sup>	0.98	1.08	1.24	ns, Max
T <sub>RCKO_FLAGS</sub>	Clock CLK to FIFO flags outputs <sup>(6)</sup>	0.65	0.74	0.89	ns, Max
T <sub>RCKO_POINTERS</sub>	Clock CLK to FIFO pointers outputs <sup>(7)</sup>	0.79	0.87	0.98	ns, Max
T <sub>RCKO_PARITY_ECC</sub>	Clock CLK to ECCPARITY in ECC encode only mode	0.66	0.72	0.80	ns, Max
T <sub>RCKO_SDBIT_ECC</sub> and T <sub>RCKO_SDBIT_ECC_REG</sub>	Clock CLK to BITERR (without output register)	2.17	2.38	3.01	ns, Max
	Clock CLK to BITERR (with output register)	0.57	0.65	0.76	ns, Max
T <sub>RCKO_RDADDR_ECC</sub> and T <sub>RCKO_RDADDR_ECC_REG</sub>	Clock CLK to RDADDR output with ECC (without output register)	0.64	0.74	0.90	ns, Max
	Clock CLK to RDADDR output with ECC (with output register)	0.71	0.79	0.92	ns, Max
<b>Setup and Hold Times Before/After Clock CLK</b>					
T <sub>RCKC_ADDRA</sub> /T <sub>RCKC_ADDRA</sub>	ADDR inputs <sup>(8)</sup>	0.38/0.27	0.42/0.28	0.48/0.31	ns, Min
T <sub>RDCK_DI_WF_NC</sub> / T <sub>RCKD_DI_WF_NC</sub>	Data input setup/hold time when block RAM is configured in WRITE_FIRST or NO_CHANGE mode <sup>(9)</sup>	0.49/0.51	0.55/0.53	0.63/0.57	ns, Min
T <sub>RDCK_DI_RF</sub> /T <sub>RCKD_DI_RF</sub>	Data input setup/hold time when block RAM is configured in READ_FIRST mode <sup>(9)</sup>	0.17/0.25	0.19/0.29	0.21/0.35	ns, Min
T <sub>RDCK_DI_ECC</sub> /T <sub>RCKD_DI_ECC</sub>	DIN inputs with block RAM ECC in standard mode <sup>(9)</sup>	0.42/0.37	0.47/0.39	0.53/0.43	ns, Min
T <sub>RDCK_DI_ECCW</sub> /T <sub>RCKD_DI_ECCW</sub>	DIN inputs with block RAM ECC encode only <sup>(9)</sup>	0.79/0.37	0.87/0.39	0.99/0.43	ns, Min
T <sub>RDCK_DI_ECC_FIFO</sub> / T <sub>RCKD_DI_ECC_FIFO</sub>	DIN inputs with FIFO ECC in standard mode <sup>(9)</sup>	0.89/0.47	0.98/0.50	1.12/0.54	ns, Min
T <sub>RCKC_INJECTBITERR</sub> / T <sub>RCKC_INJECTBITERR</sub>	Inject single/double bit error in ECC mode	0.49/0.30	0.55/0.31	0.63/0.34	ns, Min
T <sub>RCKC_EN</sub> /T <sub>RCKC_EN</sub>	Block RAM Enable (EN) input	0.30/0.17	0.33/0.18	0.38/0.20	ns, Min
T <sub>RCKC_REGCE</sub> /T <sub>RCKC_REGCE</sub>	CE input of output register	0.21/0.13	0.25/0.13	0.31/0.14	ns, Min
T <sub>RCKC_RSTREG</sub> /T <sub>RCKC_RSTREG</sub>	Synchronous RSTREG input	0.25/0.06	0.27/0.06	0.29/0.06	ns, Min
T <sub>RCKC_RSTRAM</sub> /T <sub>RCKC_RSTRAM</sub>	Synchronous RSTRAM input	0.27/0.35	0.29/0.37	0.31/0.39	ns, Min
T <sub>RCKC_WEA</sub> /T <sub>RCKC_WEA</sub>	Write Enable (WE) input (Block RAM only)	0.38/0.15	0.41/0.16	0.46/0.17	ns, Min
T <sub>RCKC_WREN</sub> /T <sub>RCKC_WREN</sub>	WREN FIFO inputs	0.39/0.25	0.39/0.30	0.40/0.37	ns, Min
T <sub>RCKC_RDEN</sub> /T <sub>RCKC_RDEN</sub>	RDEN FIFO inputs	0.36/0.26	0.36/0.30	0.37/0.37	ns, Min
<b>Reset Delays</b>					
T <sub>RCO_FLAGS</sub>	Reset RST to FIFO flags/pointers <sup>(10)</sup>	0.76	0.83	0.93	ns, Max
T <sub>RREC_RST</sub> /T <sub>RREM_RST</sub>	FIFO reset recovery and removal timing <sup>(11)</sup>	1.59/-0.68	1.76/-0.68	2.01/-0.68	ns, Max

## DSP48E1 Switching Characteristics

Table 32: DSP48E1 Switching Characteristics

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
<b>Setup and Hold Times of Data/Control Pins to the Input Register Clock</b>					
$T_{DSPDCK\_A\_AREG}/T_{DSPCKD\_A\_AREG}$	A input to A register CLK	0.24/0.12	0.27/0.14	0.31/0.16	ns
$T_{DSPDCK\_B\_BREG}/T_{DSPCKD\_B\_BREG}$	B input to B register CLK	0.28/0.13	0.32/0.14	0.39/0.15	ns
$T_{DSPDCK\_C\_CREG}/T_{DSPCKD\_C\_CREG}$	C input to C register CLK	0.15/0.15	0.17/0.17	0.20/0.20	ns
$T_{DSPDCK\_D\_DREG}/T_{DSPCKD\_D\_DREG}$	D input to D register CLK	0.21/0.19	0.27/0.22	0.35/0.26	ns
$T_{DSPDCK\_ACIN\_AREG}/T_{DSPCKD\_ACIN\_AREG}$	ACIN input to A register CLK	0.21/0.12	0.24/0.14	0.27/0.16	ns
$T_{DSPDCK\_BCIN\_BREG}/T_{DSPCKD\_BCIN\_BREG}$	BCIN input to B register CLK	0.22/0.13	0.25/0.14	0.30/0.15	ns
<b>Setup and Hold Times of Data Pins to the Pipeline Register Clock</b>					
$T_{DSPDCK\_{A,B}\_MREG\_MULT}/T_{DSPCKD\_{A,B}\_MREG\_MULT}$	{A, B,} input to M register CLK using multiplier	2.04/-0.01	2.34/-0.01	2.79/-0.01	ns
$T_{DSPDCK\_{A,B}\_ADREG}/T_{DSPCKD\_{A,B}\_ADREG}$	{A, D} input to AD register CLK	1.09/-0.02	1.25/-0.02	1.49/-0.02	ns
<b>Setup and Hold Times of Data/Control Pins to the Output Register Clock</b>					
$T_{DSPDCK\_{A,B}\_PREG\_MULT}/T_{DSPCKD\_{A,B}\_PREG\_MULT}$	{A, B,} input to P register CLK using multiplier	3.41/-0.24	3.90/-0.24	4.64/-0.24	ns
$T_{DSPDCK\_D\_PREG\_MULT}/T_{DSPCKD\_D\_PREG\_MULT}$	D input to P register CLK using multiplier	3.33/-0.62	3.81/-0.62	4.53/-0.62	ns
$T_{DSPDCK\_{A,B}\_PREG}/T_{DSPCKD\_{A,B}\_PREG}$	A or B input to P register CLK not using multiplier	1.47/-0.24	1.68/-0.24	2.00/-0.24	ns
$T_{DSPDCK\_C\_PREG}/T_{DSPCKD\_C\_PREG}$	C input to P register CLK not using multiplier	1.30/-0.22	1.49/-0.22	1.78/-0.22	ns
$T_{DSPDCK\_PCIN\_PREG}/T_{DSPCKD\_PCIN\_PREG}$	PCIN input to P register CLK	1.12/-0.13	1.28/-0.13	1.52/-0.13	ns
<b>Setup and Hold Times of the CE Pins</b>					
$T_{DSPDCK\_{CEA;CEB}\_{AREG;BREG}}/T_{DSPCKD\_{CEA;CEB}\_{AREG;BREG}}$	{CEA; CEB} input to {A; B} register CLK	0.30/0.05	0.36/0.06	0.44/0.09	ns
$T_{DSPDCK\_CEC\_CREG}/T_{DSPCKD\_CEC\_CREG}$	CEC input to C register CLK	0.24/0.08	0.29/0.09	0.36/0.11	ns
$T_{DSPDCK\_CED\_DREG}/T_{DSPCKD\_CED\_DREG}$	CED input to D register CLK	0.31/-0.02	0.36/-0.02	0.44/-0.02	ns
$T_{DSPDCK\_CEM\_MREG}/T_{DSPCKD\_CEM\_MREG}$	CEM input to M register CLK	0.26/0.15	0.29/0.17	0.33/0.20	ns
$T_{DSPDCK\_CEP\_PREG}/T_{DSPCKD\_CEP\_PREG}$	CEP input to P register CLK	0.31/0.01	0.36/0.01	0.45/0.01	ns
<b>Setup and Hold Times of the RST Pins</b>					
$T_{DSPDCK\_{RSTA;RSTB}\_{AREG;BREG}}/T_{DSPCKD\_{RSTA;RSTB}\_{AREG;BREG}}$	{RSTA, RSTB} input to {A, B} register CLK	0.34/0.10	0.39/0.11	0.47/0.13	ns
$T_{DSPDCK\_RSTC\_CREG}/T_{DSPCKD\_RSTC\_CREG}$	RSTC input to C register CLK	0.06/0.22	0.07/0.24	0.08/0.26	ns
$T_{DSPDCK\_RSTD\_DREG}/T_{DSPCKD\_RSTD\_DREG}$	RSTD input to D register CLK	0.37/0.06	0.42/0.06	0.50/0.07	ns
$T_{DSPDCK\_RSTM\_MREG}/T_{DSPCKD\_RSTM\_MREG}$	RSTM input to M register CLK	0.18/0.18	0.20/0.21	0.23/0.24	ns
$T_{DSPDCK\_RSTP\_PREG}/T_{DSPCKD\_RSTP\_PREG}$	RSTP input to P register CLK	0.24/0.01	0.26/0.01	0.30/0.01	ns
<b>Combinatorial Delays from Input Pins to Output Pins</b>					
$T_{DSPDO\_A\_CARRYOUT\_MULT}$	A input to CARRYOUT output using multiplier	3.21	3.69	4.39	ns
$T_{DSPDO\_D\_P\_MULT}$	D input to P output using multiplier	3.15	3.61	4.30	ns

## Device Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Values are expressed in nanoseconds unless otherwise noted.

**Table 40: Clock-Capable Clock Input to Output Delay Without MMCM/PLL (Near Clock Region)**

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>without</i> MMCM/PLL.						
TICKOF	Clock-capable clock input and OUTFF <i>without</i> MMCM/PLL (near clock region)	XC7V585T	5.63	6.20	6.97	ns
		XC7V2000T	N/A	5.66	6.35	ns
		XC7VX330T	5.41	5.97	6.71	ns
		XC7VX415T	5.46	5.96	6.70	ns
		XC7VX485T	5.29	5.84	6.57	ns
		XC7VX550T	5.45	6.02	6.76	ns
		XC7VX690T	5.46	6.02	6.76	ns
		XC7VX980T	N/A	6.12	6.87	ns
		XC7VX1140T	N/A	5.59	6.28	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.

**Table 41: Clock-Capable Clock Input to Output Delay Without MMCM/PLL (Far Clock Region)**

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>without</i> MMCM/PLL.						
TICKOFFAR	Clock-capable clock input and OUTFF <i>without</i> MMCM/PLL (far clock region)	XC7V585T	6.81	7.53	8.44	ns
		XC7V2000T	N/A	6.00	6.73	ns
		XC7VX330T	6.31	6.97	7.83	ns
		XC7VX415T	6.36	6.90	7.69	ns
		XC7VX485T	6.20	6.86	7.69	ns
		XC7VX550T	6.66	7.37	8.27	ns
		XC7VX690T	6.69	7.37	8.27	ns
		XC7VX980T	N/A	7.47	8.37	ns
		XC7VX1140T	N/A	5.93	6.65	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.

Table 42: Clock-Capable Clock Input to Output Delay With MMCM

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>with</i> MMCM.						
TICKOFMMCMCC	Clock-capable clock input and OUTFF <i>with</i> MMCM	XC7V585T	1.07	1.07	1.07	ns
		XC7V2000T	N/A	0.82	0.82	ns
		XC7VX330T	1.01	1.01	1.01	ns
		XC7VX415T	1.07	1.07	1.07	ns
		XC7VX485T	0.91	0.91	0.91	ns
		XC7VX550T	0.97	0.97	0.97	ns
		XC7VX690T	1.07	1.07	1.07	ns
		XC7VX980T	N/A	0.96	0.96	ns
		XC7VX1140T	N/A	0.82	0.82	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.
2. MMCM output jitter is already included in the timing calculation.

Table 43: Clock-Capable Clock Input to Output Delay With PLL

Symbol	Description	Device	Speed Grade			Units
			-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>with</i> PLL.						
TICKOFPPLLCC	Clock-capable clock input and OUTFF <i>with</i> PLL	XC7V585T	0.96	0.96	0.96	ns
		XC7V2000T	N/A	0.71	0.71	ns
		XC7VX330T	0.90	0.90	0.90	ns
		XC7VX415T	0.96	0.96	0.96	ns
		XC7VX485T	0.80	0.80	0.80	ns
		XC7VX550T	0.86	0.86	0.86	ns
		XC7VX690T	0.96	0.96	0.96	ns
		XC7VX980T	N/A	0.85	0.85	ns
		XC7VX1140T	N/A	0.71	0.71	ns

**Notes:**

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net in a single SLR.
2. PLL output jitter is already included in the timing calculation.

Table 44: Pin-to-Pin, Clock-to-Out using BUFI0

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
SSTL15 Clock-Capable Clock Input to Output Delay using Output Flip-Flop, Fast Slew Rate, <i>with</i> BUFI0.					
TICKOFCFS	Clock-to-out of I/O clock for HR I/O banks	4.93	5.52	6.20	ns
	Clock-to-out of I/O clock for HP I/O banks	4.85	5.44	6.11	ns

## Additional Package Parameter Guidelines

The parameters in this section provide the necessary values for calculating timing budgets for Virtex-7 T and XT FPGA clock transmitter and receiver data-valid windows.

*Table 50: Package Skew*

Symbol	Description	Device	Package	Value	Units
T <sub>PKGSKEW</sub>	Package Skew <sup>(1)</sup>	XC7V585T	FFG1157	232	ps
			FFG1761	255	ps
		XC7V2000T	FHG1761	308	ps
			FLG1925	266	ps
		XC7VX330T	FFG1157	170	ps
			FFG1761	270	ps
		XC7VX415T	FFG1157	203	ps
			FFG1158	237	ps
			FFG1927	183	ps
		XC7VX485T	FFG1157	191	ps
			FFG1158	209	ps
			FFG1761	274	ps
			FFG1927	209	ps
			FFG1930	304	ps
		XC7VX550T	FFG1158	217	ps
			FFG1927	254	ps
		XC7VX690T	FFG1157	239	ps
			FFG1158	217	ps
			FFG1761	284	ps
			FFG1926	238	ps
			FFG1927	254	ps
			FFG1930	287	ps
		XC7VX980T	FFG1926	242	ps
			FFG1928	199	ps
			FFG1930	243	ps
		XC7VX1140T	FLG1926	271	ps
			FLG1928	216	ps
			FLG1930	279	ps

**Notes:**

1. These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from die pad to ball.
2. Package delay information is available for these device/package combinations. This information can be used to deskew the package.

Table 57: GTX Transceiver User Clock Switching Characteristics<sup>(1)(2)</sup>

Symbol	Description	Data Width Conditions		Speed Grade			Units
		Internal Logic	Interconnect Logic	-3/-2G <sup>(3)</sup>	-2/-2L <sup>(3)</sup>	-1 <sup>(4)</sup>	
F <sub>TXOUT</sub>	TXOUTCLK maximum frequency			412.500	412.500	312.500	MHz
F <sub>RXOUT</sub>	RXOUTCLK maximum frequency			412.500	412.500	312.500	MHz
F <sub>TXIN</sub>	TXUSRCLK maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	390.625	322.266	250.000	MHz
F <sub>RXIN</sub>	RXUSRCLK maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	390.625	322.266	250.000	MHz
F <sub>TXIN2</sub>	TXUSRCLK2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	390.625	322.266	250.000	MHz
		64-bit	64-bit	195.313	161.133	125.000	MHz
F <sub>RXIN2</sub>	RXUSRCLK2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	390.625	322.266	250.000	MHz
		64-bit	64-bit	195.313	161.133	125.000	MHz

**Notes:**

1. Clocking must be implemented as described in the 7 Series FPGAs GTX/GTH Transceiver User Guide ([UG476](#)).
2. These frequencies are not supported for all possible transceiver configurations.
3. For speed grades -3, -2, -2L, and -2G, a 16-bit data path can only be used for speeds less than 6.6 Gb/s.
4. For speed grade -1, a 16-bit data path can only be used for speeds less than 5.0 Gb/s. For speed grade -1C with V<sub>CCINT</sub> = 0.9V, as described in the *Lowering Power using the Voltage Identification Bit* application note ([XAPP555](#)), a 16-bit data path can only be used for speeds less than 3.8 Gb/s.

Table 58: GTX Transceiver Transmitter Switching Characteristics

Symbol	Description	Condition	Min	Typ	Max	Units
F <sub>GTXTX</sub>	Serial data rate range		0.500	–	F <sub>GTXMAX</sub>	Gb/s
T <sub>RTX</sub>	TX rise time	20%–80%	–	40	–	ps
T <sub>FTX</sub>	TX fall time	80%–20%	–	40	–	ps
T <sub>LLSKEW</sub>	TX lane-to-lane skew <sup>(1)</sup>		–	–	500	ps
V <sub>TXOOBVDP</sub>	Electrical idle amplitude		–	–	15	mV
T <sub>TXOOBTRANSITION</sub>	Electrical idle transition time		–	–	140	ns
TJ <sub>12.5</sub>	Total jitter <sup>(2)(4)</sup>	12.5 Gb/s	–	–	0.28	UI
DJ <sub>12.5</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>11.18</sub>	Total jitter <sup>(2)(4)</sup>	11.18 Gb/s	–	–	0.28	UI
DJ <sub>11.18</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>10.3125</sub>	Total jitter <sup>(2)(4)</sup>	10.3125 Gb/s	–	–	0.28	UI
DJ <sub>10.3125</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>9.953</sub>	Total jitter <sup>(2)(4)</sup>	9.953 Gb/s	–	–	0.28	UI
DJ <sub>9.953</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>9.8</sub>	Total jitter <sup>(2)(4)</sup>	9.8 Gb/s	–	–	0.28	UI
DJ <sub>9.8</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>8.0</sub>	Total jitter <sup>(2)(4)</sup>	8.0 Gb/s	–	–	0.30	UI
DJ <sub>8.0</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.15	UI
TJ <sub>6.6_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	6.6 Gb/s	–	–	0.28	UI
DJ <sub>6.6_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI

Table 58: GTX Transceiver Transmitter Switching Characteristics (Cont'd)

Symbol	Description	Condition	Min	Typ	Max	Units
TJ <sub>6.6_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	6.6 Gb/s	—	—	0.30	UI
DJ <sub>6.6_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>5.0</sub>	Total jitter <sup>(3)(4)</sup>	5.0 Gb/s	—	—	0.30	UI
DJ <sub>5.0</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>4.25</sub>	Total jitter <sup>(3)(4)</sup>	4.25 Gb/s	—	—	0.30	UI
DJ <sub>4.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.75</sub>	Total jitter <sup>(3)(4)</sup>	3.75 Gb/s	—	—	0.30	UI
DJ <sub>3.75</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.15	UI
TJ <sub>3.20</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(5)</sup>	—	—	0.20	UI
DJ <sub>3.20</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.10	UI
TJ <sub>3.20L</sub>	Total jitter <sup>(3)(4)</sup>	3.20 Gb/s <sup>(6)</sup>	—	—	0.32	UI
DJ <sub>3.20L</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.16	UI
TJ <sub>2.5</sub>	Total jitter <sup>(3)(4)</sup>	2.5 Gb/s <sup>(7)</sup>	—	—	0.20	UI
DJ <sub>2.5</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.08	UI
TJ <sub>1.25</sub>	Total jitter <sup>(3)(4)</sup>	1.25 Gb/s <sup>(8)</sup>	—	—	0.15	UI
DJ <sub>1.25</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.06	UI
TJ <sub>500</sub>	Total jitter <sup>(3)(4)</sup>	500 Mb/s	—	—	0.10	UI
DJ <sub>500</sub>	Deterministic jitter <sup>(3)(4)</sup>		—	—	0.03	UI

**Notes:**

1. Using same REFCLK input with TX phase alignment enabled for up to 12 consecutive transmitters (three fully populated GTX Quads).
2. Using QPLL\_FBDIV = 40, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
3. Using CPLL\_FBDIV = 2, 20-bit internal data width. These values are NOT intended for protocol specific compliance determinations.
4. All jitter values are based on a bit-error ratio of 1e<sup>-12</sup>.
5. CPLL frequency at 3.2 GHz and TXOUT\_DIV = 2.
6. CPLL frequency at 1.6 GHz and TXOUT\_DIV = 1.
7. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 2.
8. CPLL frequency at 2.5 GHz and TXOUT\_DIV = 4.

Table 59: GTX Transceiver Receiver Switching Characteristics

Symbol	Description		Min	Typ	Max	Units
$F_{GTXRX}$	Serial data rate	RX oversampler not enabled	0.500	—	$F_{GTXMAX}$	Gb/s
$T_{RXELECIDLE}$	Time for RXELECIDLE to respond to loss or restoration of data		—	10	—	ns
$RX_{OOBVDP}$	OOB detect threshold peak-to-peak		60	—	150	mV
$RX_{SST}$	Receiver spread-spectrum tracking <sup>(1)</sup>	Modulated @ 33 KHz	-5000	—	0	ppm
$RX_{RL}$	Run length (CID)		—	—	512	UI
$RX_{PPMTOL}$	Data/REFCLK PPM offset tolerance	Bit rates ≤ 6.6 Gb/s	-1250	—	1250	ppm
		Bit rates > 6.6 Gb/s and ≤ 8.0 Gb/s	-700	—	700	ppm
		Bit rates > 8.0 Gb/s	-200	—	200	ppm
<b>SJ Jitter Tolerance<sup>(2)</sup></b>						
$JT_{SJ12.5}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	12.5 Gb/s	0.3	—	—	UI
$JT_{SJ11.18}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	11.18 Gb/s	0.3	—	—	UI
$JT_{SJ10.32}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	10.32 Gb/s	0.3	—	—	UI
$JT_{SJ9.95}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	9.95 Gb/s	0.3	—	—	UI
$JT_{SJ9.8}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	9.8 Gb/s	0.3	—	—	UI
$JT_{SJ8.0}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	8.0 Gb/s	0.44	—	—	UI
$JT_{SJ6.6\_QPLL}$	Sinusoidal jitter (QPLL) <sup>(3)</sup>	6.6 Gb/s	0.48	—	—	UI
$JT_{SJ6.6\_CPLL}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	6.6 Gb/s	0.44	—	—	UI
$JT_{SJ5.0}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	5.0 Gb/s	0.44	—	—	UI
$JT_{SJ4.25}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	4.25 Gb/s	0.44	—	—	UI
$JT_{SJ3.75}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.75 Gb/s	0.44	—	—	UI
$JT_{SJ3.2}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(4)</sup>	0.45	—	—	UI
$JT_{SJ3.2L}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(5)</sup>	0.45	—	—	UI
$JT_{SJ2.5}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	2.5 Gb/s <sup>(6)</sup>	0.5	—	—	UI
$JT_{SJ1.25}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	1.25 Gb/s <sup>(7)</sup>	0.5	—	—	UI
$JT_{SJ500}$	Sinusoidal jitter (CPLL) <sup>(3)</sup>	500 Mb/s	0.4	—	—	UI
<b>SJ Jitter Tolerance with Stressed Eye<sup>(2)</sup></b>						
$JT_{TJSE3.2}$	Total jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.70	—	—	UI
$JT_{TJSE6.6}$		6.6 Gb/s	0.70	—	—	UI
$JT_{SJSE3.2}$	Sinusoidal jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.1	—	—	UI
$JT_{SJSE6.6}$		6.6 Gb/s	0.1	—	—	UI

**Notes:**

1. Using RXOUT\_DIV = 1, 2, and 4.
2. All jitter values are based on a bit error ratio of  $1e^{-12}$ .
3. The frequency of the injected sinusoidal jitter is 80 MHz.
4. CPLL frequency at 3.2 GHz and RXOUT\_DIV = 2.
5. CPLL frequency at 1.6 GHz and RXOUT\_DIV = 1.
6. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 2.
7. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 4.
8. Composite jitter with RX equalizer enabled. DFE disabled.

Table 63: CEI-6G and CEI-11G Protocol Characteristics (GTX Transceivers)

Description	Line Rate (Mb/s)	Interface	Min	Max	Units
<b>CEI-6G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(1)</sup>	4976–6375	CEI-6G-SR	–	0.3	UI
		CEI-6G-LR	–	0.3	UI
<b>CEI-6G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(1)</sup>	4976–6375	CEI-6G-SR	0.6	–	UI
		CEI-6G-LR	0.95	–	UI
<b>CEI-11G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(2)</sup>	9950–11100	CEI-11G-SR	–	0.3	UI
		CEI-11G-LR/MR	–	0.3	UI
<b>CEI-11G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(2)</sup>	9950–11100	CEI-11G-SR	0.65	–	UI
		CEI-11G-MR	0.65	–	UI
		CEI-11G-LR	0.825	–	UI

**Notes:**

1. Tested at most commonly used line rate of 6250 Mb/s using 390.625 MHz reference clock.
2. Tested at line rate of 9950 Mb/s using 155.46875 MHz reference clock and 11100 Mb/s using 173.4375 MHz reference clock.

Table 64: SFP+ Protocol Characteristics (GTX Transceivers)

Description	Line Rate (Mb/s)	Min	Max	Units
<b>SFP+ Transmitter Jitter Generation</b>				
Total transmitter jitter	9830.40 <sup>(1)</sup>	–	0.28	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			
<b>SFP+ Receiver Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	9830.40 <sup>(1)</sup>	0.7	–	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			

**Notes:**

1. Line rated used for CPRI over SFP+ applications.

Table 72: GTH Transceiver User Clock Switching Characteristics<sup>(1)</sup>

Symbol	Description	Data Width Conditions		Speed Grade			Units
		Internal Logic	Interconnect Logic	-3E/-2GE <sup>(2)</sup>	-2(C&I)/-2LE <sup>(2)</sup>	-1(C&I) <sup>(3)</sup>	
F <sub>TXOUT</sub>	TXUSERCLKOUT maximum frequency			412.500	412.500	312.500	MHz
F <sub>RXOUT</sub>	RXUSERCLKOUT maximum frequency			412.500	412.500	312.500	MHz
F <sub>TXIN</sub>	TXUSERCLKIN maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	409.375	353.125	265.625	MHz
F <sub>RXIN</sub>	RXUSERCLKIN maximum frequency	16-bit	16-bit and 32-bit	412.500	412.500	312.500	MHz
		32-bit	32-bit	409.375	353.125	265.625	MHz
F <sub>TXIN2</sub>	TXUSERCLKIN2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	409.375	353.125	265.625	MHz
		64-bit	64-bit	204.688	176.563	132.813	MHz
F <sub>RXIN2</sub>	RXUSERCLKIN2 maximum frequency	16-bit	16-bit	412.500	412.500	312.500	MHz
		16-bit and 32-bit	32-bit	409.375	353.125	265.625	MHz
		64-bit	64-bit	204.688	176.563	132.813	MHz

**Notes:**

- Clocking must be implemented as described in the 7 Series FPGAs GTX/GTH Transceiver User Guide ([UG476](#)).
- For speed grades -3E, -2GE, -2C, -2L, and -2LE, a 16-bit data path can only be used for speeds less than 6.6 Gb/s.
- For speed grade -1 (and when V<sub>CCINT</sub> = 0.9V), a 16-bit data path can only be used for speeds less than 5.0 Gb/s.

Table 73: GTH Transceiver Transmitter Switching Characteristics

Symbol	Description	Condition	Min	Typ	Max	Units
F <sub>GTHTX</sub>	Serial data rate range		0.500	–	F <sub>GTHMAX</sub>	Gb/s
T <sub>RTX</sub>	TX rise time	20%–80%	–	40	–	ps
T <sub>FTX</sub>	TX fall time	80%–20%	–	40	–	ps
T <sub>LLSKEW</sub>	TX lane-to-lane skew <sup>(1)</sup>		–	–	500	ps
V <sub>TXOOBVDP</sub>	Electrical idle amplitude		–	–	15	mV
T <sub>TXOOBTRANSITION</sub>	Electrical idle transition time		–	–	140	ns
TJ <sub>13.1</sub>	Total jitter <sup>(2)(4)</sup>	13.1 Gb/s	–	–	0.3	UI
DJ <sub>13.1</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>12.5</sub>	Total jitter <sup>(2)(4)</sup>	12.5 Gb/s	–	–	0.28	UI
DJ <sub>12.5</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>11.3</sub>	Total jitter <sup>(2)(4)</sup>	11.3 Gb/s	–	–	0.28	UI
DJ <sub>11.3</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>10.3125_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	10.3125 Gb/s	–	–	0.28	UI
DJ <sub>10.3125_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>10.3125_CPLL</sub>	Total jitter <sup>(3)(4)</sup>	10.3125 Gb/s	–	–	0.33	UI
DJ <sub>10.3125_CPLL</sub>	Deterministic jitter <sup>(3)(4)</sup>		–	–	0.17	UI
TJ <sub>9.953</sub>	Total jitter <sup>(2)(4)</sup>	9.953 Gb/s	–	–	0.28	UI
DJ <sub>9.953</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>9.8</sub>	Total jitter <sup>(2)(4)</sup>	9.8 Gb/s	–	–	0.28	UI
DJ <sub>9.8</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI
TJ <sub>8.0_QPLL</sub>	Total jitter <sup>(2)(4)</sup>	8.0 Gb/s	–	–	0.28	UI
DJ <sub>8.0_QPLL</sub>	Deterministic jitter <sup>(2)(4)</sup>		–	–	0.17	UI

Table 74: GTH Transceiver Receiver Switching Characteristics

Symbol	Description		Min	Typ	Max	Units
F <sub>GTHRX</sub>	Serial data rate	RX oversampler not enabled	0.500	—	F <sub>GTHMAX</sub>	Gb/s
T <sub>RXELECIDLE</sub>	Time for RXELECIDLE to respond to loss or restoration of data		—	10	—	ns
RX <sub>OOBVDPP</sub>	OOB detect threshold peak-to-peak		60	—	150	mV
RX <sub>SST</sub>	Receiver spread-spectrum tracking <sup>(1)</sup>	Modulated @ 33 KHz	-5000	—	0	ppm
RX <sub>RL</sub>	Run length (CID)		—	—	512	UI
RX <sub>PPMTOL</sub>	Data/REFCLK PPM offset tolerance	Bit rates ≤ 6.6 Gb/s	-1250	—	1250	ppm
		Bit rates > 6.6 Gb/s and ≤ 8.0 Gb/s	-700	—	700	ppm
		Bit rates > 8.0 Gb/s	-200	—	200	ppm
<b>SJ Jitter Tolerance<sup>(2)</sup></b>						
JT_SJ <sub>13.1</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	13.1 Gb/s	0.3	—	—	UI
JT_SJ <sub>12.5</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	12.5 Gb/s	0.3	—	—	UI
JT_SJ <sub>11.3</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	11.3 Gb/s	0.3	—	—	UI
JT_SJ <sub>10.32_QPLL</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	10.32 Gb/s	0.3	—	—	UI
JT_SJ <sub>10.32_CPLL</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	10.32 Gb/s	0.3	—	—	UI
JT_SJ <sub>9.8</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	9.8 Gb/s	0.3	—	—	UI
JT_SJ <sub>8.0_QPLL</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	8.0 Gb/s	0.44	—	—	UI
JT_SJ <sub>8.0_CPLL</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	8.0 Gb/s	0.42	—	—	UI
JT_SJ <sub>6.6_QPLL</sub>	Sinusoidal jitter (QPLL) <sup>(3)</sup>	6.6 Gb/s	0.48	—	—	UI
JT_SJ <sub>6.6_CPLL</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	6.6 Gb/s	0.44	—	—	UI
JT_SJ <sub>5.0</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	5.0 Gb/s	0.44	—	—	UI
JT_SJ <sub>4.25</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	4.25 Gb/s	0.44	—	—	UI
JT_SJ <sub>3.75</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.75 Gb/s	0.44	—	—	UI
JT_SJ <sub>3.2</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(4)</sup>	0.45	—	—	UI
JT_SJ <sub>3.2L</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	3.2 Gb/s <sup>(5)</sup>	0.45	—	—	UI
JT_SJ <sub>2.5</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	2.5 Gb/s <sup>(6)</sup>	0.5	—	—	UI
JT_SJ <sub>1.25</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	1.25 Gb/s <sup>(7)</sup>	0.5	—	—	UI
JT_SJ <sub>500</sub>	Sinusoidal jitter (CPLL) <sup>(3)</sup>	500 Mb/s	0.4	—	—	UI
<b>SJ Jitter Tolerance with Stressed Eye<sup>(2)</sup></b>						
JT_TJSE <sub>3.2</sub>	Total jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.70	—	—	UI
JT_TJSE <sub>6.6</sub>		6.6 Gb/s	0.70	—	—	UI
JT_SJSE <sub>3.2</sub>	Sinusoidal jitter with stressed eye <sup>(8)</sup>	3.2 Gb/s	0.1	—	—	UI
JT_SJSE <sub>6.6</sub>		6.6 Gb/s	0.1	—	—	UI

**Notes:**

1. Using RXOUT\_DIV = 1, 2, and 4.
2. All jitter values are based on a bit error ratio of  $1e^{-12}$ .
3. The frequency of the injected sinusoidal jitter is 80 MHz.
4. CPLL frequency at 3.2 GHz and RXOUT\_DIV = 2.
5. CPLL frequency at 1.6 GHz and RXOUT\_DIV = 1.
6. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 2.
7. CPLL frequency at 2.5 GHz and RXOUT\_DIV = 4.
8. Composite jitter with RX equalizer enabled. DFE disabled.

Table 78: CEI-6G and CEI-11G Protocol Characteristics (GTH Transceivers)

Description	Line Rate (Mb/s)	Interface	Min	Max	Units
<b>CEI-6G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(1)</sup>	4976–6375	CEI-6G-SR	–	0.3	UI
		CEI-6G-LR	–	0.3	UI
<b>CEI-6G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(1)</sup>	4976–6375	CEI-6G-SR	0.6	–	UI
		CEI-6G-LR	0.95	–	UI
<b>CEI-11G Transmitter Jitter Generation</b>					
Total transmitter jitter <sup>(2)</sup>	9950–11100	CEI-11G-SR	–	0.3	UI
		CEI-11G-LR/MR	–	0.3	UI
<b>CEI-11G Receiver High Frequency Jitter Tolerance</b>					
Total receiver jitter tolerance <sup>(2)</sup>	9950–11100	CEI-11G-SR	0.65	–	UI
		CEI-11G-MR	0.65	–	UI
		CEI-11G-LR	0.825	–	UI

**Notes:**

1. Tested at most commonly used line rate of 6250 Mb/s using 390.625 MHz reference clock.
2. Tested at line rate of 9950 Mb/s using 155.46875 MHz reference clock and 11100 Mb/s using 173.4375 MHz reference clock.

Table 79: SFP+ Protocol Characteristics (GTH Transceivers)

Description	Line Rate (Mb/s)	Min	Max	Units
<b>SFP+ Transmitter Jitter Generation</b>				
Total transmitter jitter	9830.40 <sup>(1)</sup>	–	0.28	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			
<b>SFP+ Receiver Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	9830.40 <sup>(1)</sup>	0.7	–	UI
	9953.00			
	10312.50			
	10518.75			
	11100.00			

**Notes:**

1. Line rated used for CPRI over SFP+ applications.

**Table 80: CPRI Protocol Characteristics (GTH Transceivers)**

Description	Line Rate (Mb/s)	Min	Max	Units
<b>CPRI Transmitter Jitter Generation</b>				
Total transmitter jitter	614.4	–	0.35	UI
	1228.8	–	0.35	UI
	2457.6	–	0.35	UI
	3072.0	–	0.35	UI
	4915.2	–	0.3	UI
	6144.0	–	0.3	UI
	9830.4	–	Note 1	UI
<b>CPRI Receiver Frequency Jitter Tolerance</b>				
Total receiver jitter tolerance	614.4	0.65	–	UI
	1228.8	0.65	–	UI
	2457.6	0.65	–	UI
	3072.0	0.65	–	UI
	4915.2	0.95	–	UI
	6144.0	0.95	–	UI
	9830.4	Note 1	–	UI

**Notes:**

- Tested per SFP+ specification, see [Table 79](#).

**Integrated Interface Block for PCI Express Designs Switching Characteristics**

More information and documentation on solutions for PCI Express designs can be found at:

<http://www.xilinx.com/technology/protocols/pciexpress.htm>

**Table 81: Maximum Performance for PCI Express Designs**

Symbol	Description	Speed Grade			Units
		-3	-2/-2L/-2G	-1	
FPIPECLK	Pipe clock maximum frequency	250.00	250.00	250.00	MHz
FUSERCLK	User clock maximum frequency	500.00	500.00	250.00	MHz
FUSERCLK2	User clock 2 maximum frequency	250.00	250.00	250.00	MHz
FRPCLK	DRP clock maximum frequency	250.00	250.00	250.00	MHz